T-1 (3mm) BLINKING LED LAMP

Part Number: WP36BGD

Green

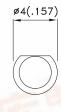
Features

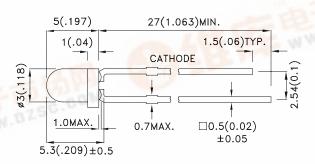
- T-1 PACKAGEWITH RECTANGULAR BASE.
- WITH BUILT-IN BLINKING IC.
- OPERATION VOLTAGE FROM 3.5V TO 14V.
- BLINKING FREQUENCY FROM 3.0Hz TO 1.5Hz.
- RoHS COMPLIANT.

Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- Tolerance is ±0.25(0.01") unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.

pecifications are subject to change without notice.





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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) V= 9V		Viewing Angle [1]
		3.	Min.	Тур.	201/2
WP36BGD	Green (GaP)	GREEN DIFFUSED	5	15	60°

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green		565		nm	
λD	Dominant Wavelength	Green		568		nm	
Δλ1/2	Spectral Line Half-width	Green		30		nm	
lF	Forward Current	Green	8	22		mA	Min:VF=3.5V Typ:VF=5V
Ison	Supply Current	Green		8		mA	V _F =3.5V
Ison	Supply Current	Green		44		mA	VF=14V
f	Blink Frequency	Green	1.5		3	Hz	VF=3.5V~14V

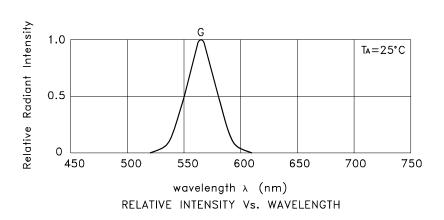
Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units		
Power dissipation	310	mW		
Forward Voltage	14	V		
Reverse Voltage	0.5	V		
Operating Temperature	-40°C To +70°C			
Storage Temperature	-40°C To +85°C			
Lead Solder Temperature [1]	260°C For 3 Seconds			
Lead Solder Temperature [2]	260°C For 5 Seconds			

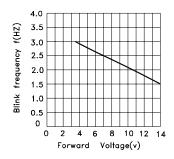
- 1. 2mm below package base.
- 2. 5mm below package base.

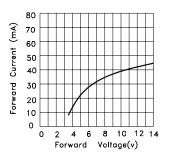
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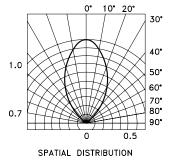
Note: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.



Green WP36BGD





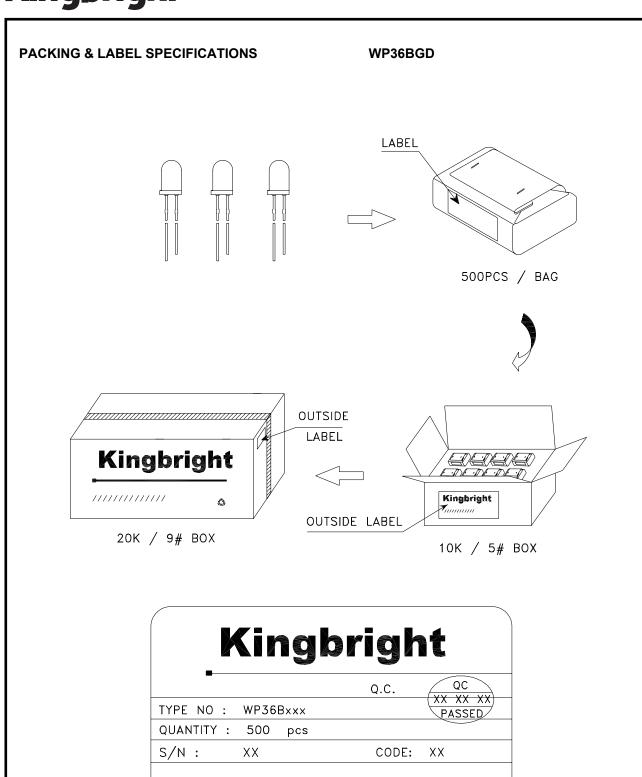


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LOT NO:

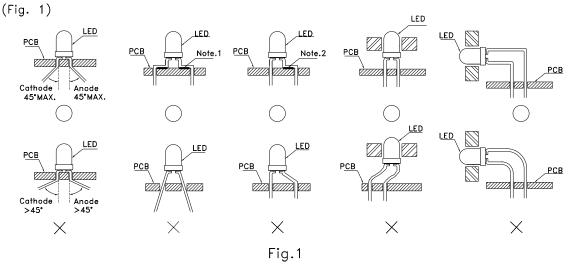
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RoHS Compliant

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LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



" \bigcirc " Correct mounting method " \times " Incorrect mounting method Note 1-2: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig. 2)

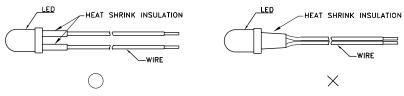
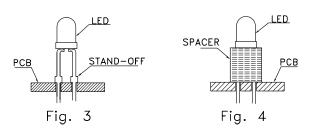


Fig. 2

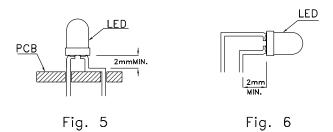
3. Use stand—offs (Fig. 3) or spacers (Fig. 4) to securely position the LED above the PCB.



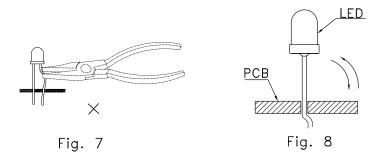
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APPROVED: WYNEC CHECKED: Allen Liu DRAWN: V.L.L. ERP: 1101003769

LEAD FORMING PROCEDURES

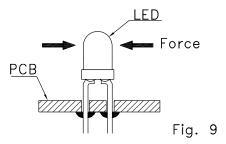
1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)



- 2. Lead forming or bending must be performed before soldering, never during or after Soldering.
- 3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.
- 4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)
- 5. Do not bend the leads more than twice. (Fig. 8)



6. After soldering or other high-temperature assembly, allow the LED to cool down to 50°C before applying outside force (Fig. 9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with Kingbright representative for proper handling procedures.



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